

L37-5S

Thermal Pad



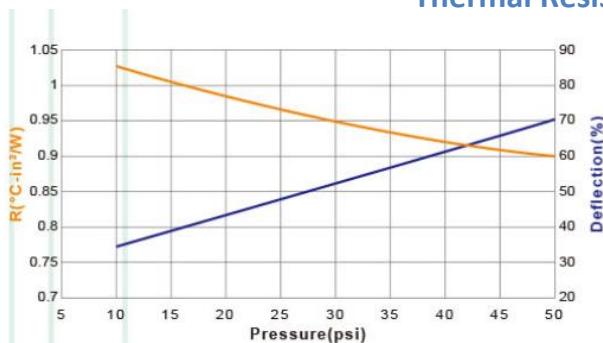
Features

- Best for filling the gap
- Compliancy, high compressibility
- Ultra soft, low hardness (Shore 00)
- Lower pressure to heated components or PCB

Applications

LCD-TV, Notebook PC, PC, Telecom Device, Wireless Hub.....etc
DDR II Module, DVD Applications, Hand-set applications.....etc

Thermal Resistance VS. Pressure VS. Deflection



Pressure (psi)	R (°C-in²/W)	Deflection (%)
10	1.03	35
30	0.95	52
50	0.90	70

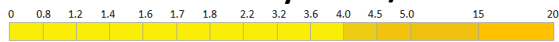
Properties

✓ REACH Compliant

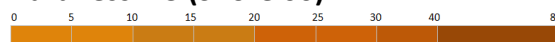
✓ RoHS Compliant

✓ UL Compliant

Thermal Conductivity: 1.8 W/m.K



Hardness: 25 (Shore 00)

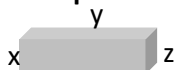


Testing sample thickness: 1.0mm

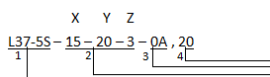
In "Thermal resistance V.S. Pressure V.S. Deflection" chart, L37-5S provides low thermal impedance. The pressure gets higher, the thermal impedance gets lower, and deflection percentage gets higher. L37-5S provides good compliance and softness.

Properties	L37-5S	Unit	Tolerance	Test Method
Thermal Conductivity	1.8	W / mK	±0.18	ASTM D5470
Thickness	0.5~5.0	mm	-	ASTM D374
	0.0197~0.1969	inch	-	ASTM D374
Color	Gray	-	-	Visual
Flame Rating	V-0	-	-	UL 94
Dielectric Breakdown Voltage	16	KV / mm	±1.6	ASTM D149
Weight Loss	<1	%	-	ASTM E595
Specific Gravity	2.4	g / cm ³	±0.2	ASTM D792
Working Temperature	-45~+200	°C	-	-
Volume Resistance	>10 ¹²	Ohm-cm	-	ASTM D257
Elongation	300	%	-	ASTM D412
Tensile Strength	1	Kgf / cm ²	-	ASTM D412
Standard Shape	Sheet ones	-	-	-
Hardness	25	Shore 00	±10	ASTM D2240

Need samples?



Available to apply adhesive



Pre-cut for different shapes

1. Choose the P/N
2. Fill into size: x, y, z
3. Apply the adhesive or not? 0= none, 1A= one side, 2A= two sides
4. Fill the quantity you need

T-Global Technology Co., Ltd

No. 33, Ln. 50, Daren Rd., Taoyuan Dist., Taoyuan City 330, Taiwan

TEL: +886-3-3618899

www.tglobalthermal.com

FAX: +886-3-3665666

www.tglobal.com.tw

